06-25-1999



IBM Docket No.: BU9-99-075

original documents or copy thereof.

1.	Name of conveying party(ies):	77784 dress of receiving party(ies):
	Mark C. Hakey	1 1 1 0 4
	William Hsioh-Lien Ma	Name: International Business Machines Corporation
		Street Address: New Orchard Road
Additi	ional name(s) of conveying party(ies) attached? [] Yes [X] No	City: Armonk State: New York
3.	Nature of Conveyance:	Zip Code: <b>10504</b>
[ <b>X</b> ] [ ]	Assignment [ ] Merger Security Agreement [ ] Change of Name Other	Additional Name(s) & Address(es) attached?  [] Yes [X] No
Execu	tion Date: 6/16/99, 6/07/99	
4.	Application number(s) or patent number(s):	/334801
	Title of Application: METHOD OF FABRICATING STR	<b>/</b>
	If this document is being filed together with a application is: 6/16/	new application, the execution date of the
	A. Patent Application No.(s) B. Pate	ent No.(s)
	Additional numbers	attached? [ ] Yes [X] No
5.	Name and address of party whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Street City:	:: DeLIO & PETERSON, LLC Address: 121 Whitney Avenue New Haven State: CT	7. Total Fee (37 CFR 3.41) \$40.00
Zip Co	ode: <u>06510-1241</u>	[ ] Enclosed
deposite the Cor	CERTIFICATE OF MAILING UNDER 37 CFR 1.10 y certify that, on the date shown below, this correspondence is being led with the United States Postal Service in an envelope addressed to mmissioner of Patents and Trademarks, Washington, D.C. 20231, as is Mail Post Office to Addressee," Mailing Label No.	Account number below [X] Any deficiencies in the enclosed fees
on	FLOHEOSICZIUS  JUNE 16, 1999  PRICTIE DODGE  f person mailing paper re LI LETTE Dodge	8. Assignee IBM Corporation Deposit Account Number:
Date: _	4/16/44	<u>09-0456</u> /
<del> </del>	DO NOT US	E THIS SPACE
To	tatement and Signature. o the best of my knowledge and belief, the foregoing info ttached copy is a true copy of the original document.	ormation is true and correct and any  Juni 16, 1999
	of Person Signing Signature	Date
Regist	ration No.: 27.465 Phone No.: (802)769-94	454
To	ital number of pages including cover sheet, attachments, a	and document: [ 2 ]

ibm100235000asgn2

**PATENT** 

**REEL: 010044 FRAME: 0650** 

## IBM Docket No.: BU9-99-075

## **ASSIGNMENT**

Whereas, we City of Fairfax Inventor and (1) Mark C. Hakey City and State of Vermont County of Franklin and City of Fishkill (2) William Hsioh-Lien Ma and State of New York County of **Dutchess** have invented certain improvements in Title METHOD OF FABRICATING STRUCTURE FOR **CHIP MICRO-JOINING** and have executed, respectively, a United States patent application therefor on Date That (1) 6/16 , 19 75, and (2) 6/7 , 19 5. Inventors Signed the Declaration Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor; Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM. (1) Signed at <u>Casey</u> Jet, <u>Vernor J</u> on <u>6/16</u>, 19 99 <u>Mark C</u> City Date (2) Signed at Fishell! City 617 ,1999 Date

ibm100235000asgn1

PAGE 1 OF 1

PATENT REEL: 010044 FRAME: 0651